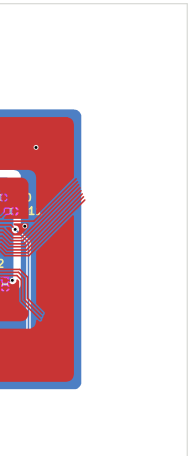


CAUTION.

Don't use it for actually selling PCBs, you MUST read the notes, the documentation and understand it fully.



PLEASE READ

Yes I know it's a lot of stuff but please read, it's important I promise



The values and observations here listed consider a two-layer, 1oz/2 PCB. A change in manufacturing parameters (layers and copper weight) will change the values. Values also pertain to the cheapest setting on the referenced manufacturer's website. Therefore even for a 2-layer 1oz/H2 PCB tolerances can be different. DO NOT use these values in other settings; always coordinate properly with your manufacturer. For clarification, read the NOTES ON TOLERANCES.

USAGE COMMENTS

This PCB file was generated by the Acheron Setup script Joker template, an automated tool to generate design-ready KICAD schematic and PCB files for keyboard projects. It is offered under a no-liability, as-is clause. Please visit https://github.com/AcheronProject/AcheronSetup/Joker_Template for more information. The files generated are compatible with KICAD developmental ("nightly") versions up to september 9, 2021 version. These files should also be accompanied of a lbrfiles folder where the used libraries are added as submodules which last commit should point to the remote's HEAD. Please note that the files need such libraries to fully work. You can safely delete this message, as long as you keep these comments in mind while using these files. For requests/issues please submit a issue in the github folder. Do not attempt to contact the developers directly. We ask that bugs/problems be reported through the issues page too.

NOTES ON TOLERANCES

The manufacturing tolerances used for PCBs in the Acheron Project are a way to uniformize the design settings of the projects. These settings were obtained using mainly three manufacturers: PCBWay, Elecrow and JLCPCB (see their capabilities pages on references [1–3]). These are big players in the asian PCB manufacturing market and the tolerances practiced by them are accepted industry-wide; hence, the values used here should be enough for most manufacturers. It must also be kept in mind that, since the Acheron Project is heavily DIY-oriented, the tolerance settings used were the easiest or cheapest available. For instance, Elecrow offers "standard PCB" and "advanced PCB" services ([2]), while PCBWay offers "normal difficulty", "medium difficulty" and "high difficulty" processes ([3]). In both manufacturers, the advanced settings have smaller tolerances and better manufacturing features but are significantly more expensive, specially when paired with PCB assembly services. Such settings are meant for more complex projects (high-speed or analog signal processing, finer electronic components, high-density designs etc) and are completely unnecessary for keyboard projects. Therefore, it must always be understood that a single body of uniform tolerances throughout a wide spectrum of projects is unfeasible due to the very nature and requirements of the different PCB projects. The values suggested here used in these files are only "recommendations" based on experience, having been used in a myriad of projects throughout the Acheron Project and in Gondolindrim's personal and professional projects. The tolerances used might seem too loose or big, but these are the bare large-scale manufacturable values found through experience using multiple factories. Adjust the values at your own discretion, but be very mindful of these tolerances as they are imperative for the manufacturing process and feasibility of the final PCB. The values used divide into two groups: the "factory minimums" and the "recommended minimum" ones.

- "Factory" are the values minimally feasible needed by factories. Different ones will inevitably have different numbers, but through using multiple a common denominator was found. These values should not be used often, but seldomly at the designer's discretion and in ultimate case, their use will incur in higher manufacturing fees, larger lead times, more quality check issues (PCBs falling after large production).
- Recommended are the smallest tolerances doable with no fabrication or quality control issues. These can be safely used without incurring in higher costs or major large-scale production issues. There is no particular reason for any of these but experience through usage of many factories. This KICAD file was set to use the recommended values in its Design Rule Checks and routines; these values were used successfully throughout the Acheron Project and are proven to work.

Keep in mind that these are, after all, minimum values. Always try to stray away from them when there is chance, so as to give you and the factory headroom to work with. The actually used values can very well vary according to your specifications and the capabilities of the factory being used. For the actual values, check references [1–3].

TLDR

You should read it all though

- The values used are based on experience but should be manufacturable at low cost and accepted industry-wide
- Such values "should" be enough for keyboard PCBs
- Manufacturing parameters might change in which case the tolerance values will change accordingly
- You can freely change these parameters around but make sure what those changes entail to, cost and production-wise
- If you are beginning on PCB design or are using a new fab, it might be wise to just use the values here for now

NOTES ON COPPER POURS

Many DIY designers will state that the usage of copper pours is perfectionism; in some cases, designers will argue that the pours are actually detrimental to the design while I (Gondolindrim) disagree with the former I agree with the latter in some respects. Ground pours are an integral part of digital high-speed signal design; since most (if not all) modern keyboards work under USB communication which uses differential pair topology, a ground copper pour is absolutely needed to ensure proper return currents paths, low ground impedance, EMI resistance, efficiency in ESD protection, protection from overheating, and so on. Particularly in keyboard PCBs, however, the copper pours make the PCBs stiffer, reducing what is known as "flex". The way to countermeasure that is by deploying flex cuts (also known as relief cuts) or leaf-spring mounting points. Use copper pours are your discretion but I (Gondolindrim) recommend always using them. My designs make liberal use of such pours even for other signals. At the bottom-right of the page there is a copper polygon with the settings generally used for the Acheron Project. The values are tuned for general use, but adjustments can be made. Thermal spoke width and relief gap can be adjusted according to the thermal needs — for THT components or connectors, it is recommended to use higher gaps (0.5mm will do the trick) to avoid bad solder joints. Avoid using hatched-pattern copper pours. They have their reason to be, but not on keyboard PCBs. They are ugly (yeah, fight me) and don't do what we want them to do here. Always use solid fills. The drawback is that they can make the PCB stiffer, so use flex cuts on the PCB.

USED TOLERANCES

FACTORY MINIMUMS

TRACK WIDTH: 0.15
COPPER CLEARANCE: 0.15 (see [1])
VIA HOLE: 0.2
VIA ANNULAR WIDTH: 0.13
VIA DIAMETER: 0.4
COPPER-TO-HOLE CLEARANCE: 0.3 (see [1][1])
COPPER-TO-EDGE CLEARANCE: 0.2
MINIMUM THROUGH HOLE DRILL: 0.2
HOLE-TO-HOLE CLEARANCE: 0.5
SILKSCREEN CHARACTER HEIGHT: 0.8
SILKSCREEN TRACE WIDTH: 0.15
SILKSCREEN CHARACTER TRACE-TO-HEIGHT RATIO: 1:6 (see [1][1])
PAD-TO-SILKSCREEN CLEARANCE: 0.15
SOLDERMASK EXPANSION: 0.05
MINIMUM SOLDERMASK BRIDGE: 0.2

ALL VALUES IN MM

RECOMMENDED

TRACK WIDTH: 0.2
COPPER CLEARANCE: 0.2
VIA HOLE: 0.3
VIA ANNULAR WIDTH: 0.15
VIA DIAMETER: 0.5
COPPER-TO-HOLE CLEARANCE: 0.4
COPPER-TO-EDGE CLEARANCE: 0.3
MINIMUM THROUGH HOLE DRILL: 0.3
HOLE-TO-HOLE CLEARANCE: 0.6
SILKSCREEN CHARACTER HEIGHT: 1.0
SILKSCREEN TRACE WIDTH: 0.2
SILKSCREEN CHARACTER TRACE-TO-HEIGHT RATIO: 1:5
PAD-TO-SILKSCREEN CLEARANCE: 0.2
SOLDERMASK EXPANSION: 0.1
MINIMUM SOLDERMASK BRIDGE: 0.3

NOTES

- [1] Official copper-copper clearances are 0.2mm but not exactly "all copper". Pad-to-pad minimums are 0.2mm.
- [1i] The recommended ratio between silkscreen character height and its trace width so they are clearly legible.
- [1ii] The hole-to-copper clearance changes on occasion. For instance, via-to-track and NPTH-to-track clearances are 0.3mm.
- [iv] The distance of copper-to-edge is a big problem for fabs in designs where traces need to be close to copper pads where the PCB traces need to be routed close to the flex cuts for lack of real-estate. This is why this value is 0.3mm.
- [v] The 1:6 ratio for silkscreen is OK for large characters but can become unreadable to the naked eye on a small board.

OVERALL DESIGN RECOMMENDATIONS

The first experience with PCB design is always very frustrating and overwhelming. There will be a lot of things you don't know, and you'll feel like you're missing some sort of black magic. Do not stray from resilience. The best way to learn PCB design is to learn from others. PCB design is a highly technical field, and electronics and embedded systems is also recommended, but higher education in maths and engineering is not necessary. Sharing your design and knowledge is one of the most fruitful and effective ways to learn design and development. Talk to other designers. This ensures a collective knowledge is achieved both in hard and soft skills. PCB design involves a lot of creativity and not everyone understands your codes and conventions. Take notes. (1) Make liberal use of the F.Fab and B.Fab layers. Those should be used for documentation while you are designing. and polarity, values, designators, everything goes to make the fab's job easier — and you can make it easier for others. (2) Treat the silkscreen layers with very good care. Make sure that the component designators are clearly visible. Also make sure that the silkscreen indicates the polarity of components either through the component designators or through the component designators and the component designators. (3) KICAD allows custom user layers. Use those to indicate screw hole anchors/sizes, plate markings, etc. In the eventualy you want to make a revision or correction, all the information is in the silkscreen or Discord conversations. (4) If you want to share or open-source your design, be kind and make sure all your thought processes are documented. a PCB, much like a computer code or a maths test, requires knowledge that is either a computer code or a maths test. (5) Yes, documenting is boring. Everyone knows that, and yet everyone takes the time to do it. Even though keyboard PCB design is very forgiving in terms of the mistakes and errors you can make, it is not. The most common problems for first-timers in keyboard PCB design are (1) USB data traces routing and routing. In this order, they are the most problematic parts of designing a keyboard PCB and are the most common problems. (1) USB DATA TRACES: make sure to route them as short as possible, parallel to one another. Also make sure they are not too close to each other. (2) BREAKING AND VIA'ING them as much as possible. If those are needed, do so in a symmetrical manner. (3) CRYSTAL TRACES: these are the highest frequency traces on the PCB and should be handled with care. (4) BYPASS CAPACITORS: the precise function and nature of bypass (also called decoupling) capacitors is a topic for electrical engineering. In layman's terms, bypass capacitors are placed to mitigate noise inherently present in digital circuits and the switching characteristic of digital circuitry. Failure to properly place and route bypass capacitors can lead to work properly. In the specific case of keyboard PCBs, there are plenty of digital circuits that require bypass capacitors, LEDs and level shifters. Treat bypass capacitors like you would a crystal: as close to the main components as possible. datasheets, reference manuals and application notes which will generally inform how many capacitors are needed.

REFERENCES

- [1] PCBWay manufacturing capabilities. Link: <<https://www.pcbway.com/capabilities.html>>. Last access august 21, 2021.
- [2] JLCPCB manufacturing capabilities. Link: <<https://jlcpcb.com/capabilities/Capabilities>>. Last accessed august 21, 2021.
- [3] Elecrow manufacturing capabilities. Link: <https://www.elecrow.com/download/quote/PCB_Specification_FAQ.pdf>. Last access august 21, 2021.
- [4] Sanjeeb Mishra, Neera Kumar Singh, Vijayakrishnan Rousseau. System on Chip Interfaces for Low Power Design. Morgan Kaufmann, 2016. ISBN 9780128016305. Accessible via <https://www.sciencedirect.com/science/article/pii/B9780128016305000104>
- [5] Seedstudio manufacturing capabilities. Link: <<https://support.seedstudio.com/knowledgebase/articles/447362-fusion-pcb-specification>>. Last accessed august 21, 2021.

EXAMPLE
COPPER
POUR